Specifications

Quality Factor (Q) is as follows when measured at 1 MHz

Capacitance Range	Min. Q		
1 to 80 pF	500 to 3000		
>80 pF	3000		

Insulation Resistance is no less than $100 \text{ G}\Omega$ when measured at 100 Vdc

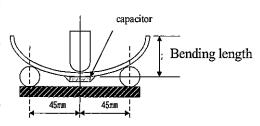
Withstanding voltage is two times the rated voltage between 5 seconds and without damage: with 50 mA or less current.

Life Test: Subject capacitors to $125 \, ^{\circ}\text{C} \pm 3 \, ^{\circ}\text{C}$ with $1.5 \, \text{times}$ rated voltage applied for $2000 \, (+72, -0)$ hours. There will be no visual damage and the capacitors will meet the limits of the table below.

Vibration Resistance: Subject the capacitors to simple harmonic motion with an amplitude of 0.06 inches; vary the frequency uniformly from 10 to 55 Hz and return to 10 Hz, all in one minute. Repeat that cycle continuously for two hours in

each of three mutually perpendicular directions. There will be no visual damage and the capacitors will meet the limits of the table below.

Bending Test: Mount the capacitor as shown below and press the ram bar until a 2.0 mm deflection is achieved. There will be no visual damage and the capacitors will meet the limits of methods JIS 5102 8.11 and AEC-Q200-005 without cracking or visual damage.



Moisture Resistance: Subject the capacitors to 40 ± 2 °C at 90 to 95% humidity for 500 (+24, -0) hours. Return to room ambient for 24 hours. There will be no visual damage and the capacitors will meet the limits of the table below.

Temperature Coefficient and

Drift: Measure the capacitors' capacitance at 25 °C, -55 °C, 25 °C, 125 °C and at 25 °C — all ±3 °C — after stabilizing at each temperature. The capacitor will meet the limits of the Characteristic table in Ordering Information.

Heat Resistance: Subject the capacitors to 125 ± 2 °C for 2 (+1,-0) hours. Then the insulation resistance will be no less than $5G\Omega$.

Solderability: After 2 ± 0.5 seconds in molten solder with Sn-PB between molten and solder at 235 ± 5 °C, solder coverage will be no less than 75% when examined at 10X magnification for flow soldering.

Solder Heat Resistance: Subject the capacitors to molten solder at 250±5 °C for 5±0.5 seconds after 10 to 30 seconds pre-heating at 80 to 120 °C. There will be no visual damage and the capacitors will meet the limits of the table below.

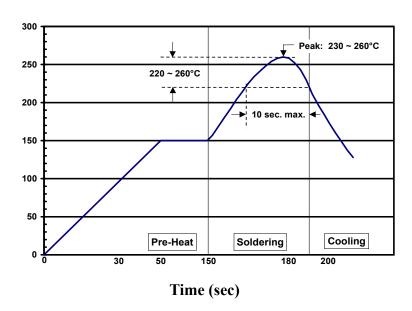
After-Test Limits

Test	Withstand	Insulation	Capacitance	DF	0
	Voltage	Resistance	(whichever >)	DF	Q
Life Test	IL	IL	IV ±2% or ±.5 pF	150% max IL	2/3 x IL
Vibration Resistance	IL	30 GΩ	IV ±1% or ±1 pF	IL	IL
Bending Test	IL		IV ±.5% or ±1 pF	IL	
Moisture Res.	IL	30 GΩ	IV ±3% or ±.5 pF	150% max IL	2/3 x IL
Solderability	IL	IL	IL	IL	IL
Heat Resistance		5 GΩ			
Solder Heat Res.	IL	30 GΩ	IV ±.5% or ±1 pF	IL	IL

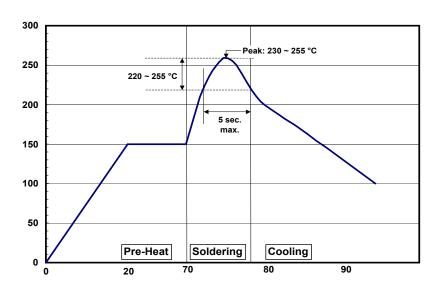
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Soldering Profiles

Reflow Solder Profile



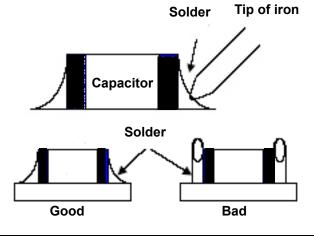
Wave Solder Profile



Time (sec)

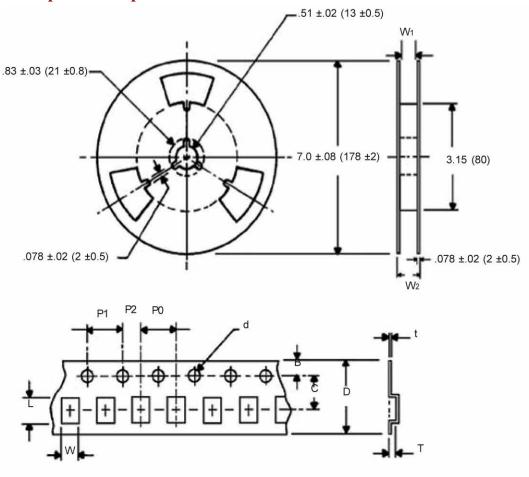
Hand Soldering Method

- SnAgCu recommended solder
- · Do not use strong acid type flux with RM or RMA
- Soldering iron tip temperature should be 250 °C to 280 °C ≤ 5 sec.
- 60 Watt iron or less



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Surface-Mount Chip Mica Capacitors for Auto Insertion



Carrier Dimensions -

lt a ma	Oursels al				Case Code				
Item	Symbol	0	8	1	2	1	8		22
Sprocket hole pitch	P1	.157 ±.008	3 (4.0 ±0.2)						
Sprocket hole location	В	.069 ±.008	(1.75 ±0.2)						
Hole center to cavity center	С	.138 ±.002	(3.5 ±0.05)			.217±.004	(5.5 ±0.1)		
Carrier tape width	D	.315 ±.012	2 (8.0 ±0.3)			.472 ±.012	(12.0 ±0.3)		
Sprocket hole diameter	d	.059	(1.5)						
Cavity pitch	P_0	.157 .004	(4.0 ±0.1)			.315 ±.008	(8.0 ±0.2)		
Hole center to cavity center	P_2	.079 ±.004	(2.0 ±0.1)						
Cavity length	L	.110	(2.8)	.150	(3.8)	.205	(5.2)	.246	(6.25)
Cavity width	W	.075 ±.008	3 (1.9 ±0.2)	.118 ±.008	3 (3.0 ±0.2)	.161 ±.008	(4.1 ±0.2)	.217 ±.00	08 (5.5 ±0.2)
Cavity depth	Т	.051 ±.004	(1.3 ±0.1)	.059 ±.004	l (1.5 ±0.1)	.071 ±.004	(1.8 ±0.1)	.087 ±.00	04 (2.2 ±0.1)
Carrier tape thickness	t	.012 ±.002	(0.3 ±0.05)						
Holder distance	W_{1}	.354	(9.0)			.512	(13.0)		
Reel thickness	W_2	about .	47 (12)			about .	63 (16)		

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